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SHARP GP2W1001YP

GP2W1001YP

■ Features

- 1. Integrated package of light emitter and receiver. (10.0×4.4×H3.5 mm)
- 2. Low profile type (Height: 3.5 mm)
- 3. Compliant with IrDA1.0 and IrDA1.1
- 4. Low voltage operation type (Supply voltage:2.4V to 5.5V)
- 5. Low dissipation current thanks to power down mode (Dissipation current at shut-doen mode:Max. $1\mu A$)
- 6. Applicable for reflow soldering
- 7. With shield case

■ Applications

- 1. Personal computers
- 2. Personal information tools

Operating temperature

Storage temperature

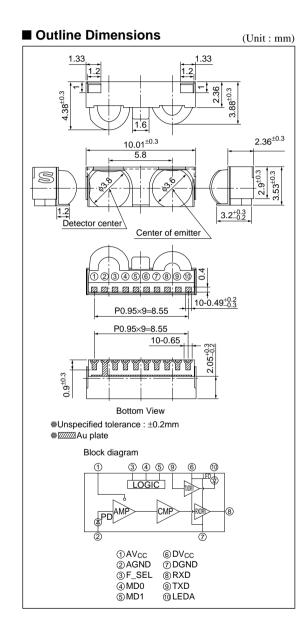
!	Absolute Maximum Ratings (Ta=25°			
	Parameter	Symbol	Rating	Unit
,	Supply voltage	Vcc	6	V
	Transmission signal duty ratio	TXduty	50	%

Note) Transmission signal duty ratio show the time share of H level of transmission wave at TX terminal. The frequency shall be 1kHz or more.

Topr

 T_{stg}

Low Profile Type IrDA Transceiver Module Compliant with IrDA1.1



°C

°C

-10 to +70

-20 to +85

I	\blacksquare Recommended Operating Conditions (Ta=25°C)						
	Parameter	Symbol	Rating	Unit			
	Operating Supply voltage	Vcc	2.7 to 5.5	V			
	Operating temperature	Topr	0 to +70	°C			
	SIR bit rate	-	9.6 to 115.2	kbps			
	FIR bit rate	_	1.152/4	Mbps			

■ Electro-optical Characteristics (Ta=25±3°C, Vcc=3.3±0.1V, 5±0.1V, Ambient illuminance of detecting face: 1001x or less)

	Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
	Dissipation current at no input signal		Icc	RXOUT:H, TXIN:L, Vcc=3.3V	-	-	1.2	mA
			1cc	RXOUT:H, TXIN:L, Vcc=5.0V –		_	1.5	mA
	S/D dissipation current		Iccs	RXOUT:H, TXIN:L, Vcc=3.3V –		0.1	1	μΑ
			Iccs	RXOUT:H, TXIN:L, Vcc=5.0V	-	0.2	2	μΑ
	Dissipation current		Iccp	Peak Value, Vcc=3.3V (2.4Ω), 5.0V (6.8Ω)	-	400	600	mA
	Switching time (Shut do	wn to stand by)	trsd		-	-	1.5	ms
	Receiver sensitiv	ity	Srxθ	SIR:9.6k to 115.2kbps 0.04 –		5 000	W/m ²	
	(-15	5°≤θ≤+15°)	Srxθ	FIR:1.152M/4Mbps 0.01		_	5 000	W/m ²
de	Low level output	voltage	Vol	Vcc=3.3, 5.0V	-	_	0.4	V
er si	High level output	voltage	Voh	Vcc=3.3, 5.0V	Vcc-0.4	_	_	V
Receiver side	Rise time		trrA	SIR:9.6k to 115.2kbps	-	_	200	ns
Rec	Kise time		t rrB	FIR:1.152M/4Mbps	-	-	40	ns
	Fall time	E H.C		SIR:9.6k to 115.2kbps	-	-	200	ns
	ran ume		tfrB	FIR:1.152M/4Mbps	-	-	40	ns
	Peak sensitivity wavelength λ _D		$\lambda_{\rm rx}$		-	940	_	nm
	$Low \ level \ pules \ width \\ $		tw1	SIR:Pulse width 19.53µs(9.6kbps), Duty 3/16	1	-	22	μs
			tw2	SIR:Pulse width 1.63µs(115.2kHz), Duty 3/16	1	_	3	μs
			tw3	FIR:Pulse width 217ns(1.152Mbps), Duty 1/4	110	_	500	ns
			tw4	FIR:Pules width Single 125ns(4Mbps), Duty 1/4	85	_	165	ns
			tw5	FIR:Pules width Double 250ns(4Mbps), Duty 1/4	210	_	290	ns
	Peak emission wavelength		λ_{tx}		850	880	900	nm
	Radiant intensity	ф=0°	Ielo	Low Power	-	15	-	mW/sr
o		ф=0°	Іемо	Middle Power	-	60	-	mW/sr
sid		-15°≤φ≤+15°	IEFθ	Full Power	100	-	500	mW/sr
tter	Low level input voltage		VIL	Vcc=3.3, 5.0V	-	-	Vcc×0.2	V
smi	High level input voltage V		VIH	Vcc=3.3, 5.0V	Vcc×0.2	_	_	V
Transmitter side	TXin terminal input current		Іін	TXIN=Vcc=5.0V	-	_	50	μΑ
I			Iπ	TXIN=GND	-0.1	0	0.1	μΑ
	Transmission signal rise time trtx		trtx				40	ns
	Transmission sign	al fall time	t ftx		_	-	40	ns

■ Truth Table

Inj	put	Output		
TXD (Transmitter) *1 Receiver		State of LED (Transmitter)	RXD terminal	
High – Low ON		ON	X	
		OFF	Low	
Low	OFF	OFF	High	

X:Do not care

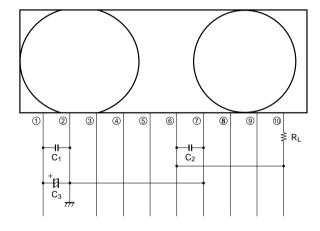
^{*1} External optical signal receiving state of photodiode

■ Input Output Logic Table

MD0	MD1	F_SEL	TXD	RXD terminal mode	TXO *2	Remarks
1	0	X	0	Shut down	Shut down	-
	0	1	0	RXA	X	Latch TXD *1
	0	1	1	RXB	X	Latch TXD *1
0	0	0	X	RXA	HPW	TXO Output High Power mode
0	1	0	X	↓ ↓	MPW	TXO Output Middle Power mode
1	1	0	X	\	LPW	TXO Output Low Power mode
0	0	1	X	RXB	HPW	TXO Output High Power mode
0	1	1	X	1	MPW	TXO Output Middle Power mode
1	1	1	X	\	LPW	TXO Output Low Power mode

^{*1} F_SFL \rightarrow 0:reset latching state of TXD, and turn to RXA channel. RXA:RXA channel mode:115kbps or less (SIR 115.2kbps, 9 600bps) RXB:RXB channel mode:115kbps or more (FIR 1.152Mbps, 4Mbps)

Fig.1 Recommended External Circuit



- 2 AGND
- ③ F_SEL
- ④ MD0
- ⑤ MD1
- ⑥ DV_{CC}⑦ DGND
- ® RXD
- ① LEDA

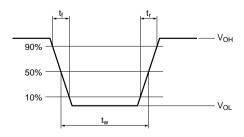
$C_1 \cdot C_2$	1μF±10% (Note 1)
C ₃	4.7μF±10% (Note 2)
	2.4Ω±5% 1/2W
Rı	(V _{CC} =3.3V)
ΝL	6.8Ω±5% 1/2W
	(\/cc=5\/)

Components Recommended values

(Note 1) Please locate nearby this transceiver choosing the ceramic capacitor with higher frequency feature

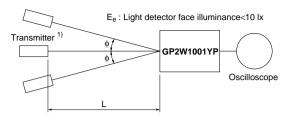
(Note 2) Please choose the most suitable C_X according to the noise level and noise frequency of power supply

Fig.2 Output Waveform Specification(Receiver side)(C∟≤10pF)



^{*2} LED operating mode

Fig.3 Standard Optical System(Receiver side)



φ: Indicates horizontal and vertical directions.

The light emitting diode (SHARP **GL710**, λp =850 to 900nm) is used as the transmitter, where the following continuous signals are transmitted.

In Fig.3, output signal shall be complete receiver side electro-optical characteristics.

Transfer rate	T ₁	T ₂	T ₂ /T ₁	Radiant intensity
9.6kbps	104μs	19.53μs	3/16	40mW/sr
115.2kbps	8.68µs	1.63µs	3/16	40mW/sr
1.152Mbps	868ns	217ns	1/4	100mW/sr
4Mbps (S)	500ns	125ns	1/4	100mW/sr
4Mbps (W)	1 000ns	250ns	1/4	100mW/sr

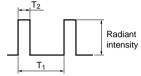


Fig.4 Output Waveform Specification(Transmitter side)

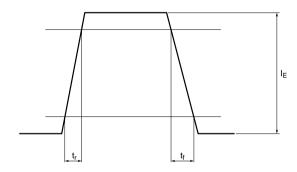


Fig.5 Standard Optical System(Transmitter side)

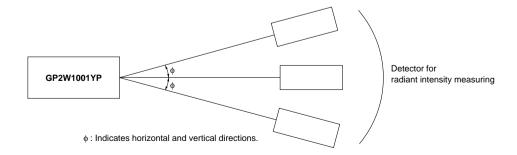


Fig.6 Recommended Circuit of Transmitter side

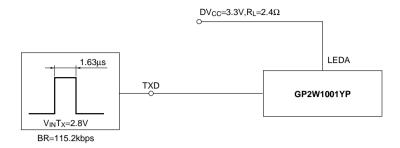


Fig.7 Peak Forward Current vs. Ambient Temperature

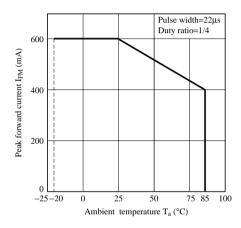


Fig.8 Recommended PCB Foot Pattern

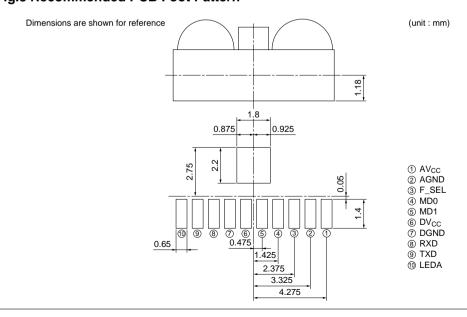
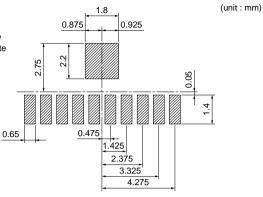


Fig.9 Recommended Size of Solder Creamed Paste (Reference)

Dimensions are shown for reference. Please open the solder mask as below so that the size of solder creamed paste for this device before reflow soldering must be as large as one of the foot pattern land indicated at Fig.8



Solder paste area

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